



Form Type	Distribute	Version	2.0	Ref	IPC 1752A	Sectionals	Manufacturing Info/ Material Info	Subsectionals	D, A																									
Supplier Information																																		
Company Name	TE Connectivity	Request Document ID		Contact Name	Cc Wu	Contact Title	Product Compliance Engineer																											
Company Unique ID	1473	Response Date	2014-05-21	Contact Email	cc.wu@te.com																													
Contact Phone Number		021-33259321																																
Legal Statement																																		
Supplier Acceptance	true																																	
Legal Statement																																		
The information provided in this document is based upon reasonable inquiry of our suppliers. This information is subject to change. This information does not in any way modify existing purchase specifications or existing contractual or other agreements terms between TE Connectivity (or its affiliated companies) and its customers.																																		
Product																																		
Manufacturer Item number	640452-2	Amount	0.15381868	Version	-	Identity																												
Manufacturer Item Name		Weight Uom	g	Mfr Site		Authority																												
Date		UOM	Each																															
EUroHS-0508	Product(s) meets EU RoHS requirement without any exemptions - true																																	
ChinaRoHS-0508	Product(s) is eligible for marking with the e code under China's Measures for Administration of the control of pollution by Electronic Information Products - true																																	
Manufacturing Information																																		
J-STD-020 MSL Rating		Max Total a Wave Time		Ramp Rate		Wave Additional Info																												
Classification Temp		Max Wave Solder Time	10.0	Ramp Down Rate		Psl Rating Reflow																												
Max Time Within 5		Psl Rating Wave		Package Designator		Size	0.0																											
Time Above 217		Reflow Additional Info		Preheat Max Temp		Terminal Base Alloy	NAC																											
Preheat Duration		bulk Solder Termination	NAC	Nbr or Reflow Cycles		Terminal Plating	NAC																											
Preheat Min Temp		Nbr of Instances	0	Component Temp Spike		Shape	NAC																											
Product Disclosure																																		
Sub-Item/Material/Substance	Level	Name	Substance Category	Substance CAS	Substance Concentration	Quantity	Mass per Unit	UOM	Exemption																									
Sub-Item	1	3-702429-2				1.07	0.089924	g																										
Material	2	Brass Wire				1.07	0.0874	g																										
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.07	1.07	6.118E-5	g																										
Substance	3	Copper	Supplier	7440-50-8	71.5	1.07	0.062491	g																										
Substance	3	Beryllium	Supplier	7440-41-7	0.0010	1.07	8.74E-7	g																										
Substance	3	Zinc	Supplier	7440-66-6	27.9975	1.07	0.02446981	g																										
Substance	3	Manganese	Supplier	7439-96-5	0.05	1.07	4.37E-5	g																										
Substance	3	Chromium	Supplier	7440-47-3	0.0010	1.07	8.74E-7	g																										
Substance	3	Iron	Supplier	7439-89-6	0.05	1.07	4.37E-5	g																										
Substance	3	Cobalt	Supplier	7440-48-4	0.1	1.07	8.74E-5	g																										
Substance	3	Arsenic	Supplier	7440-38-2	0.01	1.07	8.74E-6	g																										
Substance	3	Antimony	Supplier	7440-36-0	0.01	1.07	8.74E-6	g																										
Substance	3	Cadmium	Cadmium/Cadmium Compounds	7440-43-9	0.01	1.07	8.74E-6	g																										
Substance	3	Mercury	Mercury/Mercury Compounds	7439-97-6	5.0E-4	1.07	4.37E-7	g																										
Substance	3	Nickel	Nickel	7440-02-0	0.2	1.07	1.748E-4	g																										
Material	2	Nickel Plate				1.07	7.3E-4	g																										
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	1.07	1.46E-6	g																										
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.1	1.07	7.3E-7	g																										
Substance	3	Nickel	Nickel	7440-02-0	99.7	1.07	7.2781E-4	g																										
Material	2	Tin Plate				1.07	0.001794	g																										
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.0999	1.07	1.792206E-6	g																										
Substance	3	Tin	Supplier	7440-31-5	99.9001	1.07	0.00179221	g																										

Sub-Item	1	Polyester Compound				1.0	0.0576	g	
Material	2	PBT				1.0	0.0576	g	
Substance	3	Benzenepropanoic acid, 3,5-bis(1,1-dimethylethyl)-4-hydroxy-, 1,1-[2,2-bis[[3-[3,5-bis(1,1-dimethylethyl)-4-hydroxyphenyl]-1-oxopropoxy]methyl]-1,3-propanediyl] ester	Supplier	6683-19-8	0.2	1.0	1.152E-4	g	
Substance	3	Ethene, homopolymer	Supplier	9002-88-4	5.0	1.0	0.00288	g	
Substance	3	Ethene, 1,1,2,2-tetrafluoro-, homopolymer	Supplier	9002-84-0	0.1	1.0	5.76E-5	g	
Substance	3	Antimony oxide (Sb2O3)	Supplier	1309-64-4	8.0	1.0	0.004608	g	
Substance	3	7-Oxabicyclo[4.1.0]heptane-3-carboxylic acid, 7-oxabicyclo[4.1.0]hept-3-ylmethyl ester	Supplier	2386-87-0	0.1	1.0	5.76E-5	g	
Substance	3	Phosphoric acid, zinc salt (2:3)	Supplier	7779-90-0	0.5	1.0	2.88E-4	g	
Substance	3	2-Propenenitrile, polymer with ethenylbenzene	Supplier	9003-54-7	0.1	1.0	5.76E-5	g	
Substance	3	Carbonic dichloride, polymer with 4,4-(1-methylethylidene)bis[2,6-dibromophenol] and 4,4-(1-methylethylidene)bis[phenol], 4-(1-methyl-1-phenylethyl)phenyl ester	Supplier	156042-31-8	30.0	1.0	0.01728	g	
Substance	3	Furan, tetrahydro-	Supplier	109-99-9	0.5	1.0	2.88E-4	g	
Substance	3	Carbonic dichloride, polymer with 4,4-(1-methylethylidene)bis[phenol], 4-(1-methyl-1-phenylethyl)phenyl ester	Supplier	111211-39-3	5.0	1.0	0.00288	g	
Substance	3	Acetic acid ethenyl ester, polymer with ethene	Supplier	24937-78-8	2.0	1.0	0.001152	g	
Substance	3	Phosphorous acid, decyl diphenyl ester	Supplier	3287-06-7	0.1	1.0	5.76E-5	g	
Substance	3	1,4-Benzenedicarboxylic acid, 1,4-dimethyl ester, polymer with 1,4-butanediol	Supplier	30965-26-5	48.4	1.0	0.0278784	g	